

CM6100

2 Channel Very Low Capacitance ESD Protection Device in CSP

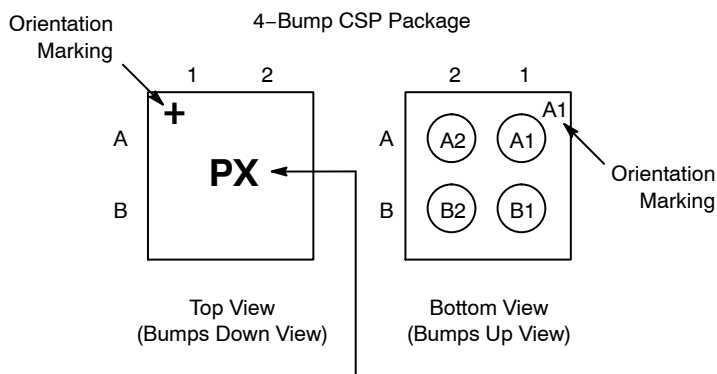
Product Description

The CM6100 is a 4-bump very low capacitance ESD protection device in 0.4 mm CSP form factor. It is fully compliant with IEC 61000-4-2. The CM6100 is RoHS II compliant.

Table 1. PIN DESCRIPTIONS

4-bump CSP Package	
Pin	Description
A1	ESD Channel 1
A2	ESD Channel 2
B1 and B2	Device Ground

PACKAGE / PINOUT DIAGRAMS



WHERE X =

A = ww01, ww02	J = ww19, ww20	S = ww37, ww38
B = ww03, ww04	K = ww21, ww22	T = ww39, ww40
C = ww05, ww06	L = ww23, ww24	U = ww41, ww42
D = ww06, ww08	M = ww25, ww26	V = ww43, ww44
E = ww08, ww10	N = ww27, ww28	W = ww45, ww46
F = ww11, ww12	O = ww29, ww30	X = ww47, ww48
G = ww13, ww14	P = ww31, ww32	Y = ww49, ww50
H = ww15, ww16	Q = ww33, ww34	Z = ww51, ww52
I = ww17, ww18	R = ww35, ww36	



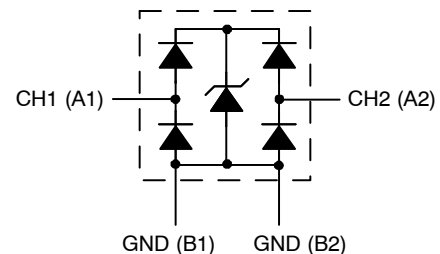
ON Semiconductor®

<http://onsemi.com>



WLCSP4
CASE 567CB

ELECTRICAL SCHEMATIC



MARKING DIAGRAM



P = CM6100
X = Single Digit Date Code

ORDERING INFORMATION

Device	Package	Shipping†
CM6100	WLCSP4 (Pb-Free)	5000/Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

CM6100

ELECTRICAL SPECIFICATIONS AND CONDITIONS

Table 2. PARAMETERS AND OPERATING CONDITIONS

Parameter	Rating	Units
Storage Temperature Range	-55 to +150	°C
Operating Temperature Range	-40 to +85	°C

Table 3. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

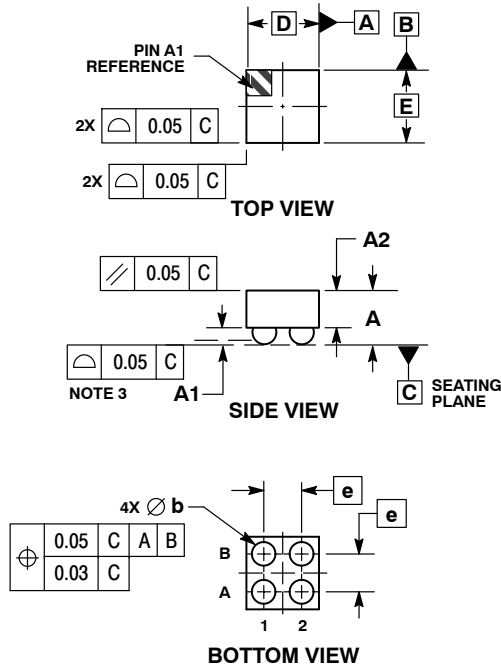
Symbol	Parameter	Conditions	Min	Typ	Max	Units
V _{IN}	Input Operating Supply Voltage			3.0	5.5	V
V _B	Breakdown Voltage (Positive)	I _F = 8 mA	6			V
I _{LEAK}	Channel Leakage Current	V _{IN} = 3 V		±0.1	±0.30	µA
C _{IN}	Channel Input Capacitance	At 1 MHz, V _{IN} = 0 V			1.5	pF
ΔC _{IN}	Channel Input Capacitance Matching	At 1 MHz, V _{IN} = 0 V		0.02		pF
V _{ESD}	ESD Protection Peak Discharge Voltage at any channel input a) Contact Discharge per IEC 61000-4-2 standard b) Air Discharge per IEC 61000-4-2 standard	(Note 2)	±8 ±15			kV
V _{CL}	Channel Clamp Voltage Positive Transients Negative Transients	I _{PP} = 1 A, t _p = 8/20 µs		+9.8 -1.5		V
R _{DYN}	Dynamic Resistance Positive Transients Negative Transients	I _{PP} = 1 A, t _p = 8/20 µs Any I/O pin to Ground		0.7 0.5		Ω

1. All parameters specified at T_A = 25°C unless otherwise noted.
2. Standard IEC 61000-4-2 with C_{Discharge} = 150 pF, R_{Discharge} = 330 Ω.

CM6100

PACKAGE DIMENSIONS

WLCSP4, 0.8x0.8
CASE 567CB-01
ISSUE O

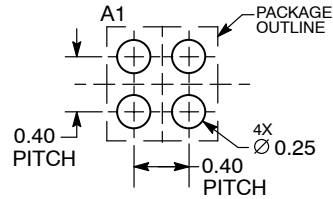


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.57	0.63
A1	0.17	0.24
A2	0.41 REF	
b	0.24	0.29
D	0.80 BSC	
E	0.80 BSC	
e	0.40 BSC	

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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